

03-26-2003

To the Honorable Commissioner of Patents and Trademarks: F



of the Department of Commerce  
Patent and Trademark Office  
by thereof.

1. Name of Conveying party(ies):  
KIHANG, Wang Chuen

3-21-03

102400882

Name: United Test & Assembly Center Limited

Additional name(s) of conveying party(ies) attached? Yes  No

Internal Address:

3. Nature of conveyance:

- Assignment
- Security Agreement
- Other
- Merger
- Change of Name



Street Address: 5 Serangoon North Avenue 5  
Singapore 554916

Execution Date: January 21, 2003

Additional name(s) and address(es) attached? Yes  No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)  
10/347,356

B. Patent No.(s)

Additional numbers attached: Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Bruce H. Bernstein  
Internal Address: P23010

Street Address: GREENBLUM & BERNSTEIN, P.L.C.  
1950 Roland Clarke Place

City: Reston State: VA ZIP: 20191

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41).....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

19-0089

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Bruce H. Bernstein, Reg. No., 29,027  
Name of Person Signing

*[Signature]*

Reg No 33, 329  
Signature

3/21/03  
Date

Total number of pages including cover sheet, attachments and document: 3

3/26/2003 EDOOPER 00000002 10347356

01 FC:8021

Mail documents to be recorded with required cover sheet information to:  
40.00 TP Commissioner of Patents & Trademarks, Box Assignments  
Washington, D.C. 20231

ASSIGNMENT

WHEREAS, **Wang Chuen KHIANG**, a citizen of Singapore, whose post office address is Blk 315C Anchorvale Road #09-180 Singapore 543315, hereinafter referred to as the ASSIGNOR, has invented a certain improvement relating to

**MULTIPLE CHIP SEMICONDUCTOR PACKAGES**

for which he has executed, on the same date as this assignment, an application for Letters Patent for the United States to be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys of record in this application including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043 and William E. Lyddane, Reg. No. 41,568, of the firm Greenblum & Bernstein, P.L.C., whose address is 1941 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. 10/347,356, filed 1/21/2003) the filing date and application number of said application when known.

AND WHEREAS, **United Test & Assembly Center Limited**, a corporation organized and existing under the laws of Singapore, whose post-office address is 5 Serangoon North Avenue 5 Singapore 554916, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNOR hereby assigns, sells and transfers to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNOR might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNOR hereby agrees to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNOR authorizes and requests the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR on the date indicated below.

  
Wang Chuen KHIANG      21 Feb 2003  
Date